

## TI IBIS-AMI Model Request Process

To request an IBIS-AMI model, please send an e-mail to [highspeed\\_models@list.ti.com](mailto:highspeed_models@list.ti.com). Please include the following information to ensure a timely response.

<b>Include in e-mail</b>	<b>Example</b>
Requestor name	John Smith
Requestor e-mail	<a href="mailto:John.Smith@AcmeNetworks.com">John.Smith@AcmeNetworks.com</a>
Company name	Acme Networks, Inc.
Device name of the model you are requesting	DS80PCI800
Project details: Describe how you will use the model.	For simulating a PCI-Express Gen3 application between a host and an end-point across a backplane including two connectors and 40 inches of total PCB trace.

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